

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mohammad Suhaib Husain	12/29/2010
Shekar Mallikarjunaswamy	02/24/2011
RECEIVING PARTY DATA	
Name:	Alpha and Omega Semiconductor (Cayman) Ltd.
Street Address:	Zephyr House, 122 Mary Street, P.O. Box 709
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
Postal Code:	KY1-1107
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13034518
CORRESPONDENCE DATA	
Fax Number:	(510)668-0239
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	5106680965
Email:	contact@jdipatent.com
Correspondent Name:	Joshua D. Isenberg
Address Line 1:	809 Corporate Way
Address Line 4:	Fremont, CALIFORNIA 94539
ATTORNEY DOCKET NUMBER:	ANO-035/US
NAME OF SUBMITTER:	Joshua D. Isenberg
Total Attachments: 2 source=ANO-035_US Scanned Assignment#page1.tif source=ANO-035_US Scanned Assignment#page2.tif	

OP \$40.00 13034518

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PATENT
REEL: 025862 FRAME: 0963

ASSIGNMENT

INVENTOR Whereas, I, **Mohammad Suhaib Husain** (Director, SiWays Microelectronics Pvt. Ltd.)
AND CITY New Delhi, India

have invented:

TITLE: **LOW LEAKAGE DYNAMIC BI-DIRECTIONAL BODY-SNATCHING (LLDBBS) SCHEME FOR HIGH SPEED ANALOG SWITCHES**
which is described in an application for Letters Patent having the above title.

I hereby authorize and request my attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont, California, to insert here in parentheses (Application number Feb. 24, 2011 JDS, filed 13034518 JDS) the filing date and application number of said application when known.

Whereas, **Alpha and Omega Semiconductor (Cayman) Ltd.**, a Cayman Islands Company with registered office at Zephyr House, 122 Mary Street, P.O. Box 709, Grand Cayman KY1-1107, Cayman Islands, British West Indies, (hereinafter called **AOS**), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to **AOS**, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to **AOS** its successors and assigns; and I hereby agree that **AOS** may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND Signed and Scaled at New Delhi (India)

DATE on December 29, 2010



SIGNATURE OF INVENTOR

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **Shekar Mallikarjunaswamy** of 258 Coffeeberry Drive
San Jose, CA 95123, USA

have invented:

TITLE:

**LOW LEAKAGE DYNAMIC BI-DIRECTIONAL BODY-
SNATCHING (LLDBBS) SCHEME FOR HIGH SPEED ANALOG
SWITCHES**

which is described in an application for Letters Patent having the above
title.

I hereby authorize and request my attorney, Joshua D. Isenberg, of 809
Corporate Way, Fremont, California, to insert here in parentheses
(Application number Feb. 24, 2011 J21, filed
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States and foreign patents to be obtained therefor;

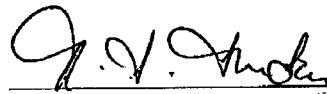
Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to **AOS**, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to **AOS** its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale, CA

DATE

on Feb 24, 2011



SIGNATURE OF INVENTOR